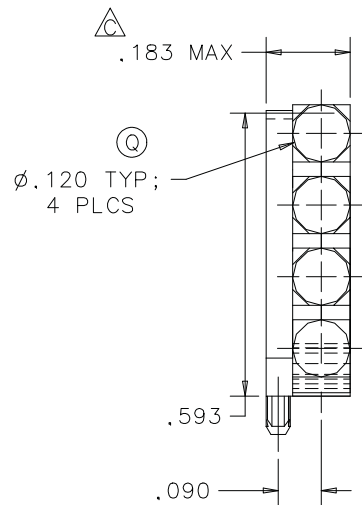
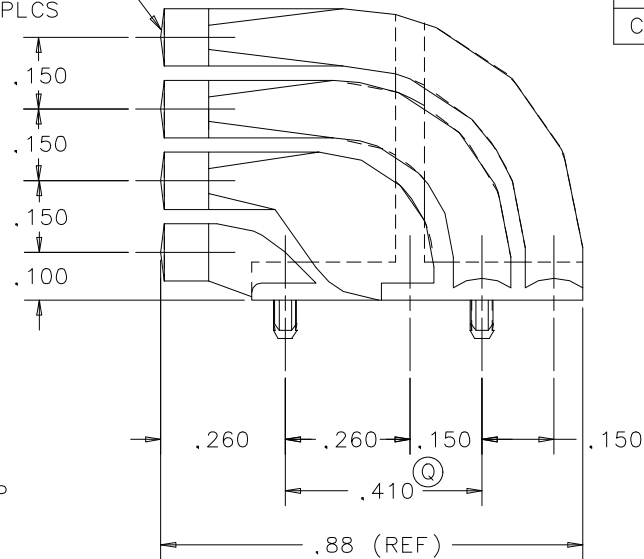


REVISIONS			
REV	ECR NO	DESCRIPTION	DATE
A	20632	NEW RELEASE	6-21-01
B	20794	REVISED SOLDER PAD LAYOUT & LED P/N'S.	
C	31345	.183 MAX WAS .175 MAX	4-9-2010

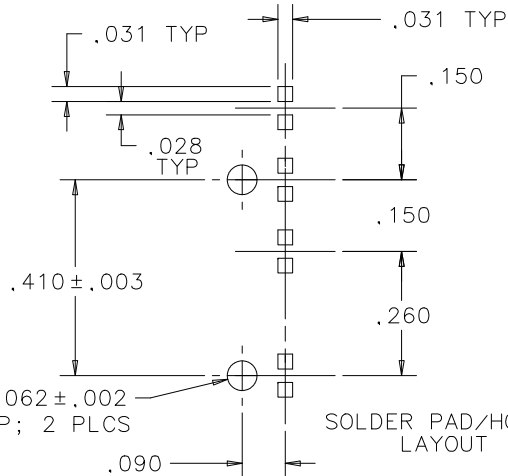


DIFFUSED FRONT SURFACES
TYP; 4 PLCS



NOTES:

1. COMPONENT TO BE MOLDED IN A CLEAR TRANSMISSIVE POLYCARBONATE WITH FLAMABILITY RATING OF 94-V0.
2. COMPONENT DESIGNED TO BE PRESS-FIT INTO .062" THICK P.C. BOARD.
3. LIGHTSOURCE: SMT LED (CML P/N: CMDA6DY7D1S YELLOW & CMDA6AR7D1S RED).



FRONT

Ø.062 ± .002
TYP; 2 PLCS

SOLDER PAD/HOLES
LAYOUT

SDRC FILE NAME: 7511B50.mf1

DIM ARE IN INCHES	☒ FOR INSPECTION USE ONLY									
	☒ SPC DOCUMENTATION REQ. (X R CHARTS)									
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	M.C.	6-8-01	7511B50							
	CHECKED BY	DATE	MODEL NO							
	ENG. APPRV.	DATE	MOLD NO		TITLE QUAD-LEVEL LIGHTPIPE					
	UNLESS OTHERWISE SPECIFIED		MATERIAL		DIST.	S	DWG NO	B17181	REV	C
	TOLERANCES ON: .XX +/- .015 .XXX +/- .010 ANGLE +/- 1 DEG.									
	FINISH				SCALE	4:1		SHEET		